

I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING SENT VIA FACSIMILE TO: COMMISSIONER  
FOR PATENTS, WASHINGTON, D.C. 20231, ON MARCH 28, 2002  
Depositor: ROSE MILLER

Rose Miller 3/28/02  
Signature And Date

CMG  
#91  
OKPN  
4/3/02

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of :

March 28, 2002

Cyprian E. Uzoh, et al :

Examiner: Hung K. Vu

Serial No. 09/611,955 :

Group Art Unit: 2811

Filing Date July 6, 2000 :

Title: Method To Selectively Fill  
Recesses With Conductive Metal :

IBM Corporation  
Dept. 18G/Bldg. 300-482  
2070 Route 52  
Hopewell Junction,  
New York 12533-6531

**AMENDMENT AFTER FINAL REJECTION**

Commissioner of Patents  
and Trademarks  
Washington, D.C. 20231

FAX COPY RECEIVED

MAR 28 2002

TECHNOLOGY CENTER 2800

Sir:

Responsive to the Final Rejection dated December 28, 2001, kindly amend the  
above-identified application as follows: